## /LPSALPINE /LPSALPINE <br> $\times$ CLOSE

Surface Mount Type TACT Switch $^{\text {TM }}>$ SKHM Series $>$ SKHMQLE010

## $6.2 \times 6.5 \mathrm{~mm}$ Type (Surface Mount) SKHM Series

## | Dimensions | Land Dimensions | Circuit Diagram | Packing Specifications | <br> | Soldering Conditions |



| Type | Surface mount |
| :--- | :--- |
| Operating force | 1.57 N |
| Operating direction | Top push |
| Travel | 0.25 mm |
| Operating life | 300,000 cycles |
| (5mA 12V DC) | Green |
| Initial contact resistance | $100 \mathrm{~m} \Omega$ max. |
| Stem color | Sharp feeling type |
| Series type | $-30^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

range

| Rating (max.) |  | 50mA 12V DC |
| :---: | :---: | :---: |
| Rating (min.) |  | 10رA 1V DC |
| Electrical | Insulation resistance | $100 \mathrm{M} \Omega \mathrm{min}$. 100 V DC for 1 min . |
| performance | Voltage proof | 250V AC for 1 min . |
| Durability | Vibration | 10 to 55 to $10 \mathrm{~Hz} / \mathrm{min}$., the amplitude is 1.5 mm for all the frequencies, in the 3 direction of $\mathrm{X}, \mathrm{Y}$ and Z for 2 hours respectively |
|  | Cold | $-30 \pm 2^{\circ} \mathrm{C}$ for 96 h |
| Environmental | Dry heat | $80 \pm 2^{\circ} \mathrm{C}$ for 96 h |
| performance | Damp heat | $60 \pm 2^{\circ} \mathrm{C}, 90$ to $95 \% \mathrm{RH}$ for 96 h |
| Minimum order | unit (pcs.) | Japan 3,000 <br> Export 3,000 |

## Dimensions



## Land Dimensions



Viewed from mounting face.

## Circuit Diagram

## Packing Specifications

## Taping



|  | 1 reel | 3,000 |
| :--- | :--- | :--- |
| Number of | 1 case / Japan | 30,000 |
| packages (pcs.) | 1 case / export <br> packing | 30,000 |
| Tape width (mm) | 12 |  |
| Export package measurements (mm) | $395 \times 395 \times 205$ |  |

## Soldering Conditions

## Condition for Reflow

1. Heating method

Double heating method with infrared heater.
2. Temperature measurement

Thermocouple 0.1 to $0.2 \Phi \mathrm{CA}(\mathrm{K})$ or $\mathrm{CC}(\mathrm{T})$ at solder joints (copper foil surface). A heat resisting tape should be used for fix measurement.
3. Temperature profile

(1) The above temperature shall be measured of the top of switch. There are cases where PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC board's and others. Care, should be taken to prevent the switch's surface temperature from exceeding $260^{\circ} \mathrm{C}$.
(2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

## Manual Soldering

Items Condition
Soldering temperature $350^{\circ} \mathrm{C}$ max.
Duration of soldering 3s max.
Capacity of soldering iron60W max.

1. Do not washing the TACT Switch ${ }^{\text {TM }}$.
2. Prevent flux penetration from the top side of the TACT switch ${ }^{\text {TM }}$.
3. Switch terminals and a PC board should not be coated with flux prior to soldering.
4. The second soldering should be done after the switch returns to normal temperature.

## Notes are common to this series/models.

1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
2. Please place purchase orders for taping products per minimum order unit (1 reel or a case).
3. For $\phi 330 \mathrm{~mm}$ diameter reel requirements, please contact us.
4. Please contact us for automotive use products.

## Inquiries about Products

Inquiry
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